

**Replacement Text for Page 5, Line 4 and Line 6 of the Specification**  
**(CLEAN FORM)**

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B<sup>1</sup> --One or more of the procedures related to dekekulization as described herein may be used in or with one or more procedures described in the following United States patent applications, which are incorporated herein: DERIVING CHEMICAL STRUCTURAL INFORMATION, serial no. 09/502,810, filed February 11, 2000, and ENHANCING STRUCTURE DIAGRAM GENERATION, serial no. 09/502,133, filed February 11, 2000.--

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